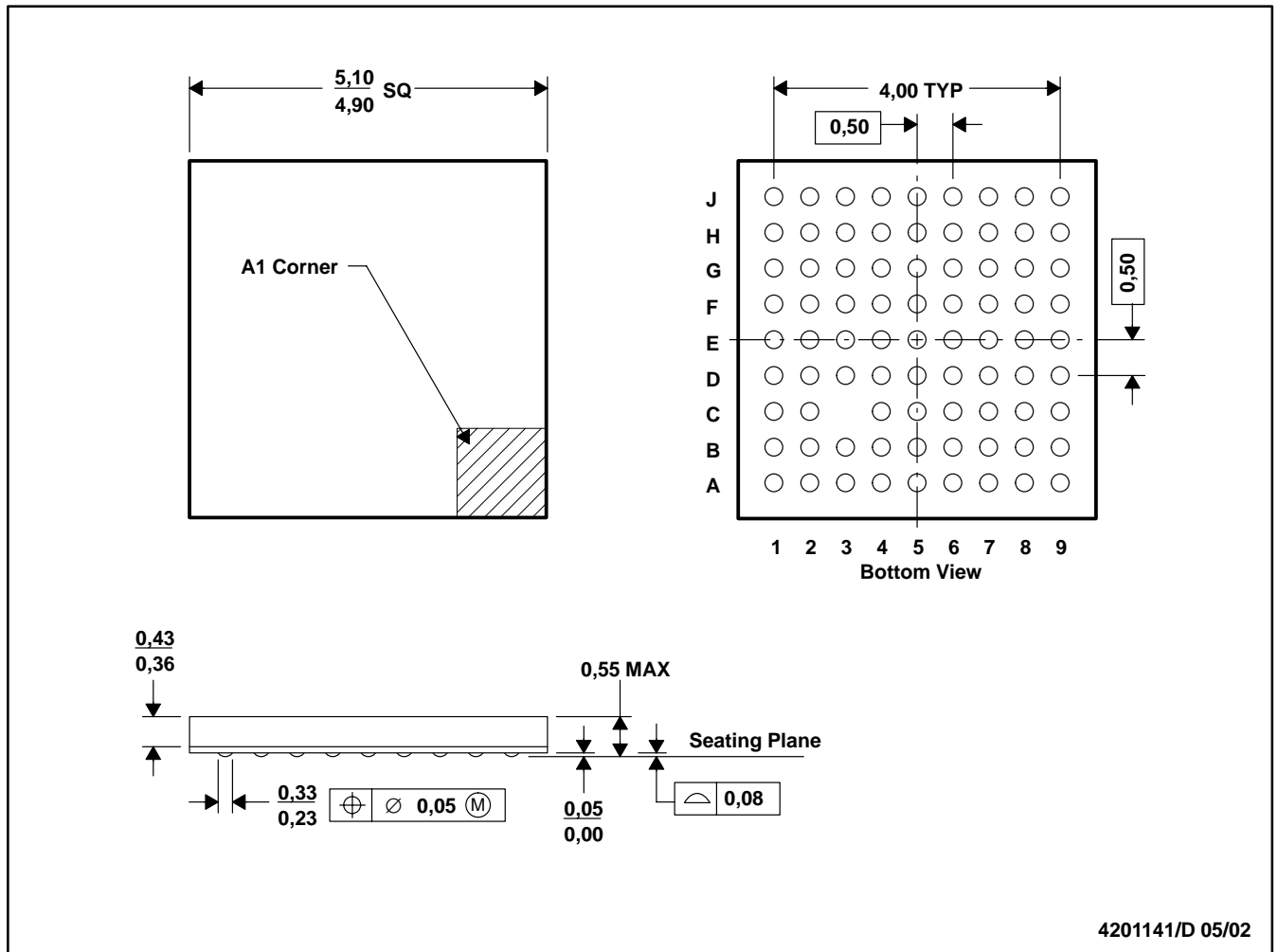


GSC (S-PLGA-N80)

PLASTIC LAND GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. MicroStar Junior™ configuration
 - D. Falls within JEDEC MO-225

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